

Cooling Buffer

Features

1. Touchscreen controller for easy operation.
2. Fully enclosed design ensures safe operation.
Durable roller drive (no belt replacement required).
3. Three modes: First-in, First-out (FIFO), Last-in, First-out (LIFO), and Pass-through.
4. Parallel, smooth width adjustment (ball screw).
5. Fast, smooth, and precise retrieval and positioning.
6. Rapid cooling effect.
7. Smooth transfer of heavy-duty PCBAs.
8. Equipped with SMEMA.

Technical Parameters	
Description	This machine is used for loading the SMT chips after the auto SMD chips counting machine
Cycle time	About 10s
PCB capacity	15pcs (pitch 30mm) or customized
Powersupply	AC1P110V/220V
Power	Max.3000V
Transport height	900±20mm(Or customized)
Transport direction	From left to right or right to left

Specifications	
Model	BF-L-TN
Dimension(L*W*H MM)	1500*1495*1760
PCB size(MM)	150*150-1200*350
Weight(KG)	300

